#### 506207794 08/17/2020

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT6254534

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
KUN-MU LI	09/25/2015
TSZ-MEI KWOK	09/25/2015
MING-HUA YU	09/26/2015
CHAN-LON YANG	09/25/2015

#### RECEIVING PARTY DATA

Name:	TAIWAN SEMICONDUCTOR MANUFACTURING CO., LTD.	
Street Address:	NO.8, LI-HSIN RD. 6, SCIENCE BASED INDUSTRIAL PARK	
City:	HSINCHU	
State/Country:	TAIWAN	
Postal Code:	300	

#### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	16995774

### **CORRESPONDENCE DATA**

Fax Number: (202)756-8087

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 202-756-8000

Email: ipdocketmwe@mwe.com

MCDERMOTT WILL & EMERY LLP **Correspondent Name:** Address Line 1: THE MCDERMOTT BUILDING

Address Line 2: 500 NORTH CAPITOL STREET, N.W.

Address Line 4: WASHINGTON, D.C. 20001

ATTORNEY DOCKET NUMBER:	095714-1318
NAME OF SUBMITTER:	LYNN CRUZ
SIGNATURE:	/Lynn Cruz/
DATE SIGNED:	08/17/2020

## **Total Attachments: 3**

source=4 095714-1318 COMBINED DECLARATION ASSIGNMENT#page1.tif source=4 095714-1318 COMBINED DECLARATION ASSIGNMENT#page2.tif

**PATENT REEL: 053517 FRAME: 0558** 506207794

source=4\_095714-1318\_COMBINED\_DECLARATION\_ASSIGNMENT#page3.tif

PATENT REEL: 053517 FRAME: 0559

## COMBINED DECLARATION AND ASSIGNMENT FOR PATENT APPLICATION

As a below named inventor, I hereby declare that:

I believe I am the original or an original joint inventor of a claimed invention in the application for which a patent is sought on the invention entitled:

## SEMICONDUCTOR DEVICE AND MANUFACTURING METHOD THEREOF

which application is:		
	attached, or	•
$\boxtimes$	United States application number or PCT international application number 14/833,022 filed on August 21, 2015.	er

The above-identified application was made or authorized to be made by me.

In the event that the filing date and/or application number are not entered above at the time I execute this document, and if such information is deemed necessary, I hereby authorize and request the registered practitioners of McDermott Will & Emery LLP, associated with the Customer Number 20277, to insert above the filing date and/or application number of the application.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

Page 1 of 3

DM\_US 63674938-1.095714.0046

P.

:11

<u>.</u>

34

Attorney Docket No. 095714-0046 P20150176US00

## **ASSIGNMENT**

For good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I hereby assign to

# TAIWAN SEMICONDUCTOR MANUFACTURING CO., LTD.

having an address at No. 8 Li-Hsin Rd. 6, Science-Based Industrial Park, Hsinchu 300 TW, (hereinafter designated as the Assignee), the entire (100%) right, title and interest for the United States as defined in 35 USC §100, in the invention described in the application identified in this document.

I hereby confirm any prior assignment to Assignee, and to the extent that I have not already done so, agree to assign, and hereby do, sell, assign and transfer unto Assignee and its successors in interest, the full and exclusive right, title and interest in the United States of America and throughout the world, including the right to claim priority under the laws of the United States, the Paris Convention, and any foreign countries, to the inventions as described in the aforesaid application, to the aforesaid application itself, and all divisions, continuations, continuations-in-part, or other applications claiming priority directly or indirectly from the aforesaid application, and any United States or foreign Letters Patent, utility model, or other similar rights which may be granted thereon, including reissues, reexaminations and extensions thereof, and all copyright rights throughout the world in the aforesaid application and the subject matter disclosed therein, these rights, title and interest to be held and enjoyed by Assignee to the full end of the term for which the Letters Patent, utility model, or other similar rights, are granted and any extensions thereof as fully and entirely as the same would have been held by the undersigned had this assignment and sale not been made, and the right to sue for, and recover for past infringements of, or liabilities for, any of the rights relating to any of the applications, patents, utility models, or other similar rights, resulting therefrom, and the copyright rights;

I hereby covenant and agree to execute all instruments or documents required or requested for the making and prosecution of any applications of any type for patent, utility model, or other similar rights, and for copyright, in the United States and in all foreign countries including, but not limited to, any provisional, continuation, continuation-in-part, divisional, renewal or substitute thereof, and as to letters patent any reissue, re-examination, or extension thereof, and for litigation regarding, or for the purpose of protecting title and to the said invention, the United States application for patent, or Letters Patent therefor, and to testify in support thereof, for the benefit of Assignee without further or other compensation than that above set forth;

I hereby covenant that no assignment, sale, license, agreement or encumbrance has been or will be entered into which would conflict with this Assignment.

Page 2 of 3

kmli 2015/09/25 10:06:57

Attorney Docket No. 095714-0046 P20150176US00

Legal name of first inventor	
Kun-Mu LI	
First inventor's signature	Date ;
Kun Ma Li	2011/9/25
Land name of second investories	
Legal name of second inventor, if any Ming-Hua YU	!
	,
Second inventor's signature	Date
China dua You	8015/9/26
	(
Legal name of third inventor, if any	
Tsz-Mei KWOK	•
Third inventor's signature	Date
TSZ Mei Knok	2015/9/25
Legal name of fourth inventor, if any	
Chan-Lon YANG	
Fourth inventor's signature	Date
CC C 5	2015/9/25